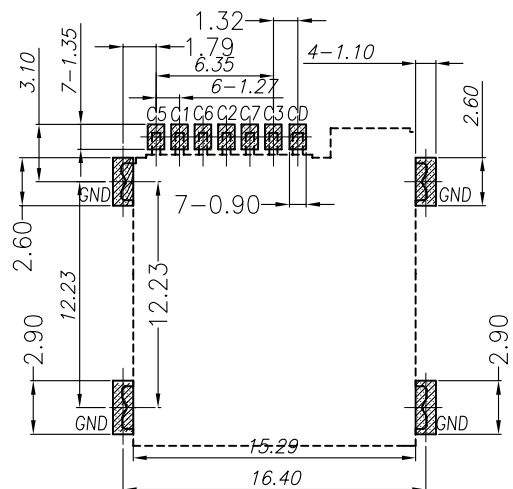
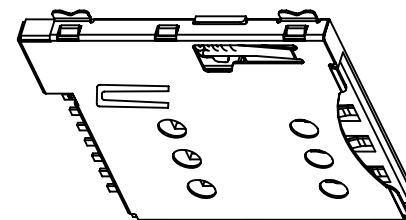
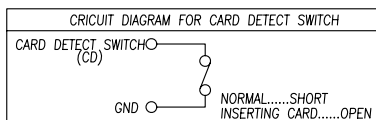
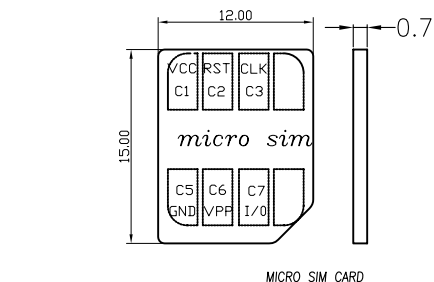


SIM pin assignment	
PIN#	Name
C1	VCC 供电电压
C2	RST 重置
C3	CLK 时钟
C5	GND 接地
C6	VPP 程序电压
C7	I/O 输入输出



PCB 焊盘区
 下沉避让区
RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05



Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy
 SHELL: SUS

PLATING:

Contact: Plated 50u'' Ni Overall Contact Au IU
 Shell: Plated 50u'' Ni Overall
 Plated 1u''Au Selective Contact Area

Electrical:

Current Rating :0.5mA AC/DC max.
 Voltage Rating :125V AC/DC
 Ambient Temperature Range :-20° C~+60° C
 Storage Temperature Range :-40° C~+70° C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100m Ω max.
 Insulation Resistance:1000M min./500VDC
 产品耐温温度: 260
 Mating Cycles:3000Min Insertions



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.' ±2' X.X' ±0.5'	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: MICRO SIM PUSH 6+1P
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC14-SIM07-135B
UNIT: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY:	DATE : 2014-02-23	DRAW NO: HYC-SIM13112801
			SHEET NO. 1 OF 1